

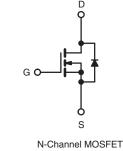
RoHS

COMPLIANT

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	100				
R _{DS(on)} (Ω)	$V_{GS} = 5.0 V$ 0.27				
Q _g (Max.) (nC)	12				
Q _{gs} (nC)	3.0				
Q _{gd} (nC)	7.1				
Configuration	Single				





FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- $R_{DS(on)}$ Specified at $V_{GS} = 4 V$ and 5 V
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRL520PbF		
	SiHL520-E3		
SnPb	IRL520		
	SiHL520		

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	100	V	
Gate-Source Voltage			V _{GS}	± 10	- V	
Continuous Drain Current	V _{GS} at 5.0 V	T _C = 25 °C	I.,	9.2	А	
	V _{GS} at 5.0 V	T _C = 100 °C	I _D	6.5		
Pulsed Drain Current ^a			I _{DM}	36		
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	170	mJ	
Avalanche Current ^a			I _{AR}	9.2	A	
Repetitive Avalanche Energy ^a			E _{AR}	6.0	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	60	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	- °C	
oldering Recommendations (Peak Temperature) for 10 s				300 ^d		
Mounting Torque	6.20 or 1	C 00 or M0 opposit		10	lbf ∙ in	
Mounting Torque	6-32 or M3 screw			1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 3.0 mH, $R_g = 25 \Omega$, $I_{AS} = 9.2 \text{ A}$ (see fig. 12).

c. $I_{SD} \leq 9.2$ A, dI/dt ≤ 110 A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 175 \ ^{\circ}C.$

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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IRL520, SiHL520

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greasd Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.5		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 10 V	-	-	± 100	nA
Zene Oete Veltere Ducin Orment	I _{DSS}	V _{DS} =	V _{DS} = 100 V, V _{GS} = 0 V		-	25	
Zero Gate Voltage Drain Current		V _{DS} = 80 V	, V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
	_	V _{GS} = 5.0 V	I _D = 5.5 A ^b	-	-	0.27	Ω
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 4.0 V$	I _D = 4.6 A ^b	-	-	0.38	
Forward Transconductance	9 _{fs}	V _{DS} :	= 50 V, I _D = 5.5 A	3.2	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	490	-	pF
Output Capacitance	C _{oss}		$V_{DS} = 25 V,$	-	150	-	
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	30	-	
Total Gate Charge	Qg			-	-	12	
Gate-Source Charge	Q _{gs}	$V_{GS} = 5.0 V$	I _D = 9.2 A, V _{DS} = 80 V, see fig. 6 and 13 ^b	-	-	3.0	nC
Gate-Drain Charge	Q _{gd}		see lig. o and to	-	-	7.1	
Turn-On Delay Time	t _{d(on)}			-	9.8	-	
Rise Time	t _r	- V _{DD} = 50 V, I _D = 9.2 A, R _g = 9.0 Ω, R _D = 5.2 Ω, see fig. 10 ^b		-	64	-	- ns
Turn-Off Delay Time	t _{d(off)}			-	21	-	
Fall Time	t _f	_			27	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal Source Inductance	L _S			-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	9.2	Α
Pulsed Diode Forward Current ^a	I _{SM}			-	-	36	
Body Diode Voltage	V_{SD}	$T_J = 25 \ ^{\circ}C, \ I_S = 9.2 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C	-0.2 A dl/dt -100 A/up	-	130	190	ns
Body Diode Reverse Recovery Charge	Q _{rr}	- T _J = 25 °C, I _F = 9.2 A, dI/dt = 100 A/µs ^b		-	0.83	1.0	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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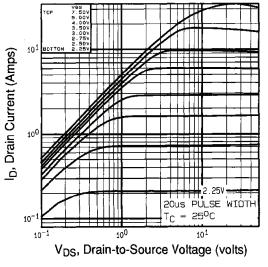


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

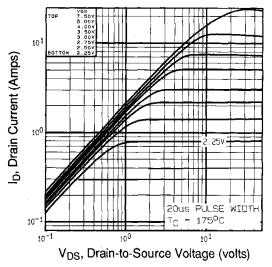


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

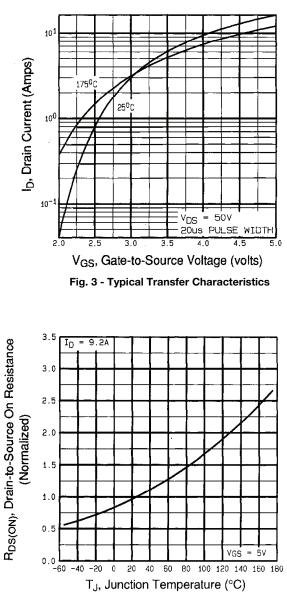


Fig. 4 - Normalized On-Resistance vs. Temperature

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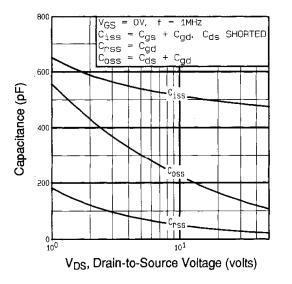
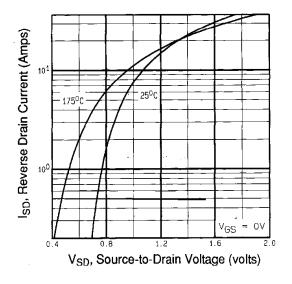
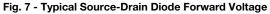


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





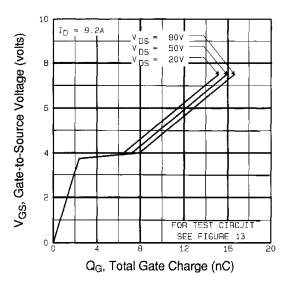


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

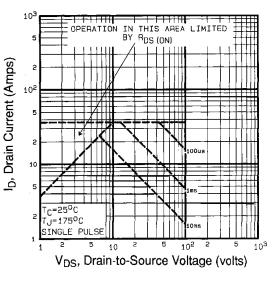


Fig. 8 - Maximum Safe Operating Area

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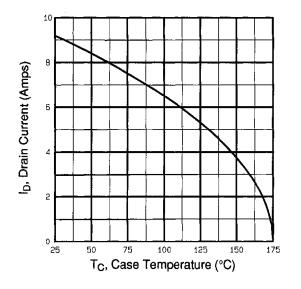


Fig. 9 - Maximum Safe Operating Area

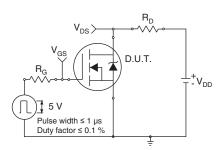


Fig. 10a - Switching Time Test Circuit

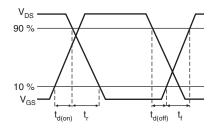


Fig. 10b - Switching Time Waveforms

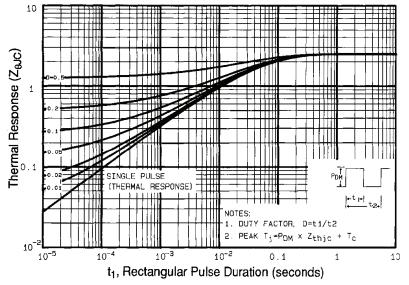


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



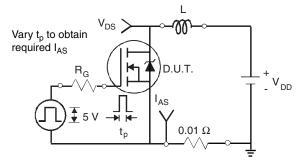


Fig. 12a - Unclamped Inductive Test Circuit

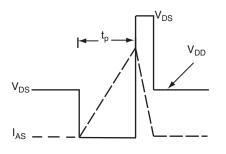


Fig. 12b - Unclamped Inductive Waveforms

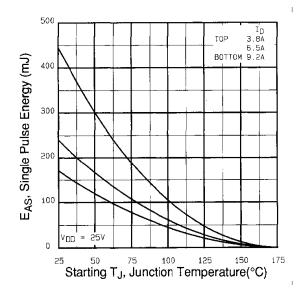


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

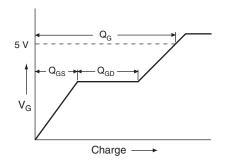


Fig. 13a - Basic Gate Charge Waveform

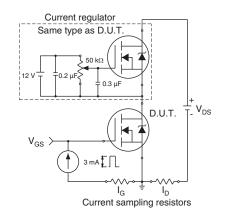


Fig. 13b - Gate Charge Test Circuit

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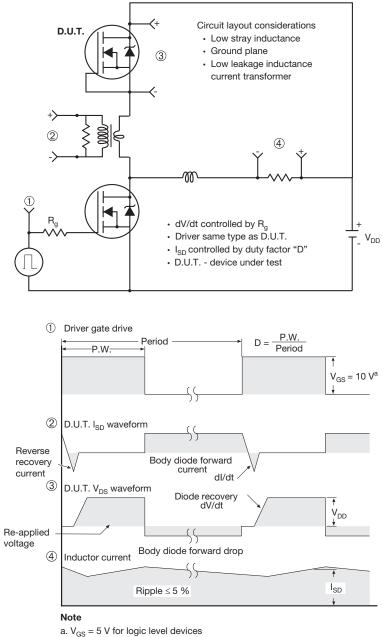


Fig. 14 - For N-Channel

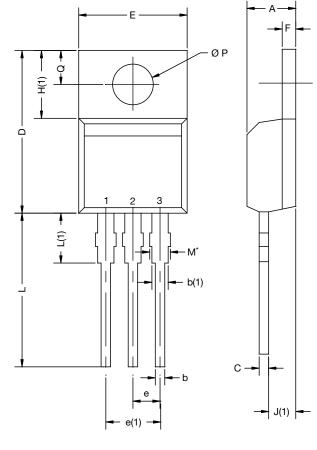
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TO-220-1

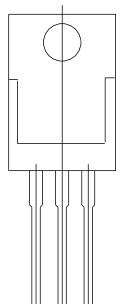


	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.14	4.70	0.163	0.185
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.73	0.045	0.068
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	0.43	1.40	0.017	0.055
H(1)	6.10	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØР	3.53	3.94	0.139	0.155
Q	2.59	3.00	0.102	0.118
ECN: X15- DWG: 603 ⁻	0003-Rev. A, I	19-Jan-15		

Notes

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

- Outline conforms to $\mathsf{JEDEC}^{\circledast}$ outline TO-220AB with exception of dimension F



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